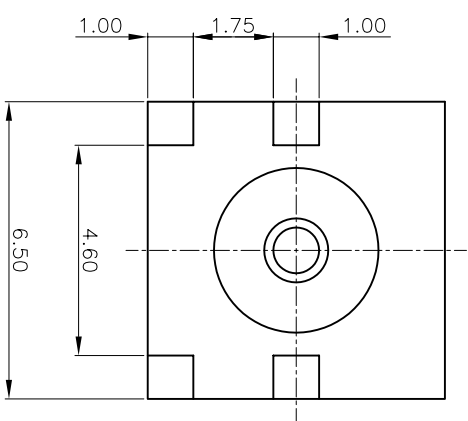
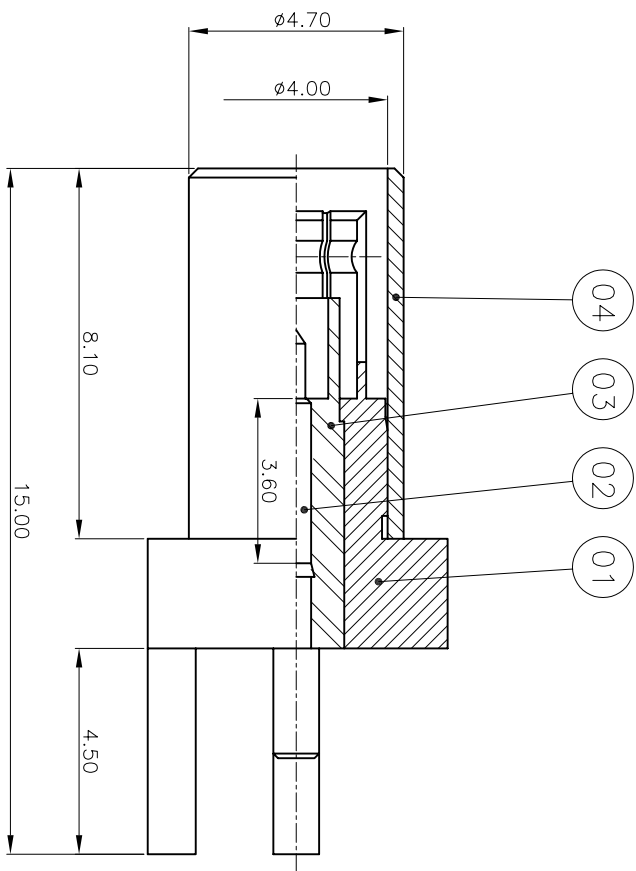


REVISION		
REV	DESCRIPTION	DATE
1R	최초 개정	2008.12.24.



4	COVER	1	MBSBD	Nickel Plate	DCU02147-5/1
3	INSULATOR	1	TEFLON		DIN01468-N/1
2	CONTACT	1	MBSBD	Gold Plate	DCT01839-5/1
1	BODY	1	MBSBD	Nickel Plate	DBD02314-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

DATE 2008. 12. 24.

APPROVED BY S.J.YOUN

CHECKED BY E.H.KIM

DRAWN BY I.C.KIM

SCALE 6/1 UNIT mm

KU COMTECH
RF & MICROWAVE TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE

SSMB50(변형)-4R-R

DWG NO. CN02251-5/1

A4 REVISION 1 R SHEET 1 of 1

TOLERANCE	Decimal ± 0.1
ANGLE	$\pm 1^\circ$
MATERIAL	
FINISH	